### BigTwin SuperServer SYS-222BT-HNR (Complete System Only 6) New



#### 2U 4-Node BigTwin with 6 hot-swap 2.5" NVMe drives per node





#### **Key Applications**

- All-Flash NVMe Hyperconverged
  Container-as-a-Service; **Application Accelerator** Infrastructure
- High-Performance File System
  Diskless HPC Clusters

#### **Key Features**

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Dual Socket E2 Intel<sup>®</sup> Xeon<sup>®</sup> 6 6700 series processors with E-cores up to 205W with air cooling or 330W with liquid cooling
  - 2. Up to 16 DIMMs supporting up to 4TB DDR5-6400 in 1DPC
  - 3. Flexible networking with OCP 3.0 AIOM slot
  - 4. Up to 2 PCle 5.0 x16 LP slots
  - Internal PCIe 5.0 for 2x NVMe M.2 support onboard Optional 4x NVMe M.2 support onboard with built-in HW RAID1 v A2NM2241GH-B1

5. Up to 6 front hot-swap 2.5" PCIe 5.0 NVMe drive bays

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**Product SKUs** 

YS-222BT-HNR

#### **Motherboard**

**Super X14DBT-B** 

### **Processor (per Node)**

CPU Dual Socket E2 (LGA-4710)

**Core Count** 

Intel® Xeon® 6700 series processors with E-cores

Up to 144C/144T; Up to 108MB Cache per CPU

Supports up to 205W TDP CPUs (Air Cooled)\* Note

Supports up to 330W TDP CPUs (Liquid Cooled) \*Air Cooled CPUs with TDP over 205W only supported under specific conditions. Contact a Supermicro representative for details.

#### **System Memory (per Node)**

Memory Slot Count: 16 DIMM slots

Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5 RDIMM View Memory Options >

### **On-Board Devices (per Node)**

**Chipset** System on Chip

**Network Connectivity** Via AIOM <u>View AIOM Options</u> >

<u>View AOC Options</u> >

## Input / Output (per Node)

1 RJ45 1 GbE Dedicated BMC LAN port

**USB** 2 USB 3.0 Gen2 Type-A ports(Rear)

1 VGA port Video

### **System BIOS**

**BIOS Type** AMI 32MB Flash ROM

# Management

**Software** <u>SuperCloud Composer</u>

Supermicro Server Manager (SSM) Super Diagnostics Offline (SDO) Supermicro Thin-Agent Service (TAS) SuperServer Automation Assistant (SAA) New!

**Power configurations** 

ACPI/APM Power Management

## Security

Trusted Platform Module (TPM) 2.0 Hardware Silicon Root of Trust (RoT) – NIST 800-193 Compliant

Cryptographically Signed Firmware

**Features** 

Secure Boot Secure Firmware Updates **Automatic Firmware Recovery** 

> Supply Chain Security: Remote Attestation **Runtime BMC Protections**

System Lockdown

## **PC Health Monitoring**

Fans with tachometer monitoring FAN

Status monitor for speed control Pulse Width Modulated (PWM) fan connectors

**Temperature** 

Monitoring for CPU and chassis environment

CPU Monitors for CPU Cores, Chipset Voltages, Memory. 8+4 Phase-switching voltage regulator

Chassis

**Form Factor** 2U Rackmount

Model CSE-217BQ2-R3K60P

**Width** 17.68" (449 mm)

**Dimensions and Weight** 

**Height** 3.47" (88 mm)

28.75" (730 mm) Depth

**Package** 9.76" (H) x 24.65" (W) x 45.28" (D)

**Weight** Gross Weight: 96.6 lbs (43.8 kg) Net Weight: 66.1 lbs (30 kg)

**Available Color** Black front & silver body

#### **Front Panel**

LED HDD activity LED **Network activity LEDs** Power status LED Universal Information (UID) LED

Power On/Off button **Buttons UID** button

**Expansion Slots (per Node)** 

PCI-Express (PCIe) Default Configuration

2 PCIe 5.0 x16 LP slots

1 PCIe 5.0 x16 AIOM slot (OCP 3.0 compatible) View AOC Options >

**Drive Bays / Storage (per Node)** 

**Drive Bays** Default: Total 6 bays Configuration

6 front hot-swap 2.5" PCIe 5.0 NVMe drive bays View NVMe Options >

**M.2** 2 M.2 PCIe 5.0 x4 NVMe slots (M-key 22110(default); VROC

required for RAID)

**System Cooling** 

**Fans** 4x 16K RPM Counter Rotating 80x80x56mm Fan(s)

**Liquid Cooling** Direct to Chip (D2C) Cold Plate (optional)

**Power Supply** 

2x 3600W Redundant (1 + 1) Titanium Level (96%) power supplies

Dimension (WxHxL) 45 x 40 x 480 mm

> **Input** 3600W: 0240Vdc / 50-60Hz (for CQC only) 1400W: 100-127Vac / 50-60Hz 3000W: 200-207.9Vac / 50-60Hz 3100W: 208-219.9Vac / 50-60Hz

3250W: 220-229.9Vac / 50-60Hz 3450W: 230-237.9Vac / 50-60Hz 3600W: 238-240Vac / 50-60Hz

Max: 112A / Min: 0A (100Vac-127Vac) +12V Max: 240A / Min: 0A (200Vac-207.9Vac) Max: 248A / Min: 0A (208Vac-219.9Vac) Max: 260A / Min: 0A (220Vac-229.9Vac) Max: 276A / Min: 0A (230Vac-237.9Vac)

Max: 288A / Min: 0A (238Vac-240Vac)

**12V SB** Max: 4.5A / Min: 0A

Backplanes (gold finger) **Output Type** 

**Operating Environment** 

**RoHS Compliant** ROHS

Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) **Environmental Spec.** Non-operating Temperature: -30°C to 60°C (-22°F to 140°F)

Operating Relative Humidity: 8% to 80% (non-condensing) Non-operating Relative Humidity: 8% to 90% (non-condensing)

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